

Dayton SPIN Meeting

Thursday, May 13, 2010

6:00pm

NEW MEETING LOCATION:

Clark State Community College
Greene Center Campus, Room G210
3775 Pentagon Boulevard (formerly New Germany-Trebein Road)
Beavercreek, OH 45431

The Greene Center campus is located just South of the Mall at Fairfield Commons.

*****Meeting Facilities Sponsored by: Clark State Community College*****

You are invited to attend the May meeting of the Dayton SPIN. Involvement with the Dayton SPIN is a great opportunity to interact with other engineering, quality and process improvement professionals in your community. There is no cost to attend. Attendees learn new techniques and share lessons learned from their experience. Please extend this invitation to any other persons who may benefit from learning more about how to apply CMMI[®] and other process improvement approaches in their organizations. Walk-ins are welcome. Door prizes are provided.

Program Topic:

“Working on a TSP Team”

This program will describe the Team Software Process (TSP) from the perspective of a project team. The presentation will include examples and case studies to illustrate the processes, practices, methods, measures and tools of the TSP.

TSP is a software development method. It was designed to help software teams manage their work and achieve best performance without the typical “death march” ending. TSP has helped projects and organizations achieve new levels of performance in terms of cost, schedule and quality. TSP was ranked as the #1 best software engineering practice for medium and large systems by Capers Jones in his latest book, Software Engineering Best Practices.

Some of the TSP topics covered in this presentation are:

- Planning and tracking methods
- Self-directed team management
- Team coaching
- How to build self-directed teams
- Measurement framework
- Team-based quality management practices
- Implementation techniques

The presentation will describe the synergy between TSP, CMMI and other practices such as SCRUM and RUP. Experiences at Microsoft, Adobe, Intuit and Oracle will be highlighted.

Be sure to attend and learn how Intuit used the “Pizza Slices Served” metric to measure work-life balance.

Speaker:

Jim Over

James W. Over, has been with the Software Engineering Institute since 1987. He is the manager of the TSP Initiative and a senior member of the technical staff for the Software Engineering Process Management Program. Over has led SEI’s TSP Initiative since its inception, transitioning the TSP into organizations in the United States and abroad. He received an award from Boeing Corporation for innovation and leadership in software process improvement. He has more than 35 year of technical and management experience in the software engineering industry. Over is the co-author of several SEI reports on software engineering and process improvement.

Agenda

The meeting will begin at **6:00 p.m.** with light refreshments, networking and brief announcements.

The speaker program will follow at **6:30 p.m.**

See the Dayton SPIN web site (<http://www.daytonspin.org>) for directions and an interactive map.

If you plan to attend, an R.S.V.P. to daytonspinpublicity@gmail.com would be appreciated.

If this is your **first attendance**, also include the following contact information if you wish to be added to the Dayton SPIN Networking Directory and notified of future Dayton SPIN events.

- 1) Your Name and Job Title
- 2) Company Name
- 3) Preferred Address
- 4) Daytime telephone number
- 5) Email address

Please Note:

Dayton SPIN now has an email address!

DaytonSPINPublicity@gmail.com

If you have any questions regarding the use of this email address, feel free to contact Casey Bretti at caseyabretti@gmail.com

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